



## **DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION**

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: Semiconductor Processor Systems, Systems Configured to Provide a Semiconductor Workpiece Process Fluid, Semiconductor Workpiece Processing Methods, Methods of Preparing Semiconductor Workpiece Process Fluid, and Methods of Delivering Semiconductor Workpiece Process Fluid to a Semiconductor Processor, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

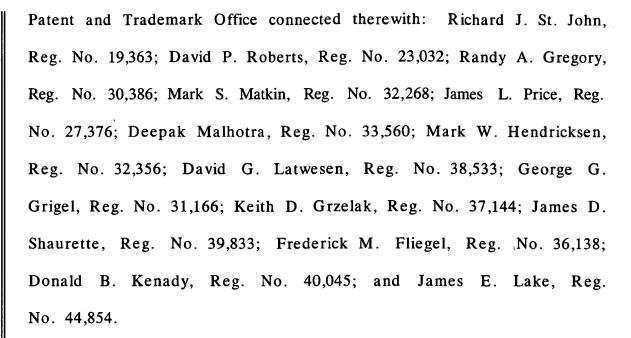
I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56.

#### PRIOR FOREIGN APPLICATIONS:

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

### **POWER OF ATTORNEY:**

As a named Inventor, I hereby appoint the following attorneys and agent to prosecute this application and transact all business in the



Direct all communications to James D. Shaurette, at WELLS, ST. JOHN, ROBERTS, GREGORY & MATKIN P.S., 601 West First Avenue, Suite 1300, Spokane, WA 99201-3828. Telephone: (509) 624-4276; (PTO Customer No. 021567).

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statement may jeopardize the validity of the application or any patent issued therefrom.





## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| Application Serial No  |  |  |  |  |
|--|--|--|--|--|
| Filing Date Filed Herewith   |  |  |  |  |
| Inventor Scott E. Moore et al.   |  |  |  |  |
| Assignee Micron Technology, Inc.   |  |  |  |  |
| Group Art Unit Unknown   |  |  |  |  |
| Examiner Unknown   |  |  |  |  |
| Attorney's Docket No   |  |  |  |  |
| Title: Semiconductor Processor Systems, Systems Configured to Provide a  |  |  |  |  |
| Semiconductor Workpiece Process Fluid, Semiconductor Workpiece           |  |  |  |  |
| Processing Methods, Methods of Preparing Semmiconductor Workpiece        |  |  |  |  |
| Process Fluid, and Methods of Delivering Semiconductor Workpiece Process |  |  |  |  |
| Fluid to a Semiconductor Processor                                       |  |  |  |  |

# POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE BY ASSIGNEE UNDER 37 CFR §3.73(b)

To: Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

MICRON TECHNOLOGY, INC., the Assignee of the entire right, title and interest in the above-identified patent application by assignment attached hereto, hereby appoints the attorneys and agents of the firm of WELLS, ST. JOHN, ROBERTS, GREGORY & MATKIN P.S., listed as follows:

| Richard J. St. John  | Reg. | No. | 19,363 |
|----------------------|------|-----|--------|
| David P. Roberts     | Reg. | No. | 23,032 |
| Randy A. Gregory     | Reg. | No. | 30,386 |
| Mark S. Matkin       | Reg. | No. | 32,268 |
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| Deepak Malhotra      | Reg. | No. | 33,560 |
| Mark W. Hendricksen  | Reg. | No. | 32,356 |
| David G. Latwesen    | Reg. | No. | 38,533 |
| George G. Grigel     | Reg. | No. | 31,166 |
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| James D. Shaurette   | Reg. | No. | 39,833 |
| Frederick M. Fliegel | Reg. | No. | 36,138 |

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Donald Brent Kenady James E. Lake Reg. No. 40,045 Reg. No. 44,854

and also attorneys Michael L. Lynch (Reg. No. 30,871) and Lia Pappas Dennison (Reg. No. 34,095) of Micron Technology, Inc., as its attorneys with full power of substitution to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

The Assignee certifies that the above-identified Assignment has been reviewed and to the best of Assignee's knowledge and belief, title is in the Assignee, and a copy of the Assignment is submitted herewith.

Please direct all correspondence regarding this application to:

Customer No. 021567
Wells, St. John, Roberts, Gregory & Matkin P.S.
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MICRON TECHNOLOGY, INC.

Dated: 2 -38 00

By:

Name:

Michael L. Lynch, Esq.

Title: Chief Patent Counsel

Attachment: Copy of Assignment; Copy of Board of Directors' Resolution

24

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| 1  | *                      | * * * * * * * *                         |
|----|------------------------|---|
| 2  | Full name of inventor: | Sc tt E. Moore                          |
| 3  | Inventor's Signature:  | Just & move                             |
| 4  | Date:                  | 2-28-00                                 |
| 5  | Residence:             | Meridian, Idaho                         |
| 6  | Citizenship :          | United States of America                |
| 7  | Post Office Address:   | 1840 East Mary Lane, Meridian, ID 83642 |
| 8  | *                      | * * * * * * * *                         |
| 9  | Full name of inventor: | Scott G. Meikle                         |
| 10 | Inventor's Signature:  | Just 6. Mente                           |
| 11 | Date:                  | 2/28/00                                 |
| 12 | Residence:             | Boise, Idaho                            |
| 13 | Citizenship:           | United States of America                |
| 14 | Post Office Address:   | 1301 East Jefferson, Boise, ID 83712    |
| 15 | *                      | * * * * * * * *                         |
| 16 | Full name of inventor: | Magdel Crum                             |
| 17 | Inventor's Signature:  |   |
| 18 | Date:                  |   |
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